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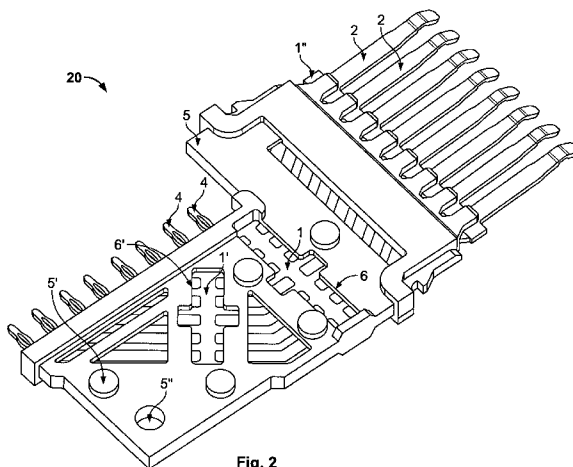


Fig. 2

(57) Abstract: A method for manufacturing an electrical contact module is provided, comprising forming a lead-frame of electrical conductors, wherein at least one supporting strip is formed in the lead-frame of electrical conductors in such a way as to maintain the electrical conductors in a predetermined position with respect to each other, over-molding the lead-frame of electrical conductors with a first dielectric material, thereby obtaining a first over-molded lead-frame, wherein at least one aperture is formed in the first over-molded lead-frame so that the at least one supporting strip is accessible for being removed, removing the at least one supporting strip in the first over-molded lead-frame after completion of the over-molding step, and over-molding the first over-molded lead-frame with a second dielectric material in such manner as to fill the at least one aperture and a space left between the electrical conductors after removal of the at least one supporting strip.

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